Docket No.: 27-409-5CP (formerly CPAC 1029-6)

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Serial Number:

10/681,747

Filing Date:

October 8, 2003

Name of Inventor(s):

Marcos Karnezos

Title of Invention:

SEMICONDUCTOR MULTI-PACKAGE MODULE HAVING INVERTED SECOND PACKAGE STACKED OVER DIE-UP FLIP-CHIP BALL GRID

ARRAY (BGA) PACKAGE

TRANSMITTAL AND REQUEST TO CHANGE POWER OF ATTORNEY TO PROSECUTE APPLICATIONS BEFORE THE USPTO, CORRESPONDENCE ADDRESS, AND ATTORNEY DOCKET NO.

Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

Dear Sir or Madam:

The Assignee of Record is the owner of the entire interest and respectfully requests:

- 1. Revocation of all previous Powers of Attorney and the appointment of Mikio Ishimaru and all practitioners associated with Customer No. 22898.
- Change of the correspondence address for the above-identified U.S. Patent Application No. 10/681,747 to the address associated with Customer No. 22898.
- Change of the Attorney Docket No. from CPAC 1029-6 to 27-409-5CP.

Enclosed are the following documents:

- Nower Of Attorney To Prosecute Applications Before The USPTO and Change of Correspondence Address
- Statement Under 37 CFR 3.73(b)
- Fee Address Indication Form PTO/SB/47

Please charge any shortage in fees due in connection with the filing of this paper to Deposit Account 50-0374 and credit any excess fees to such Deposit Account.

Respectfully submitted,

Mikio Ishimaru Reg. No. 27,449

January 18, 2008

Certificate of Transmission

I hereby certify that these documents are being electronically transmitted to the U.S. Patent and Trademark Office via EFS from the Pacific

Time zone on January 18, 2008

Victoria Rocha

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